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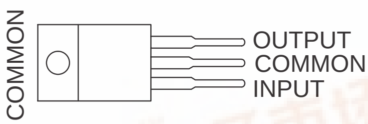
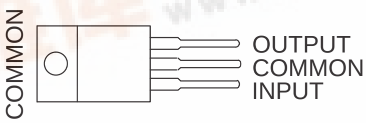
- **3-Terminal Regulators**
- **Output Current up to 1.5 A**
- **Internal Thermal-Overload Protection**
- **High Power-Dissipation Capability**
- **Internal Short-Circuit Current Limiting**
- **Output Transistor Safe-Area Compensation**

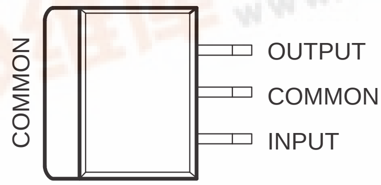
KC (TO-220) PACKAGE
(TOP VIEW)



KCS (TO-220) PACKAGE
(TOP VIEW)



KTE PACKAGE
(TOP VIEW)



description/ordering information

This series of fixed-voltage integrated-circuit voltage regulators is designed for a wide range of applications. These applications include on-card regulation for elimination of noise and distribution problems associated with single-point regulation. Each of these regulators can deliver up to 1.5 A of output current. The internal current-limiting and thermal-shutdown features of these regulators essentially make them immune to overload. In addition to use as fixed-voltage regulators, these devices can be used with external components to obtain adjustable output voltages and currents, and also can be used as the power-pass element in precision regulators.

ORDERING INFORMATION

T_J	$V_{O(NOM)}$ (V)	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 125°C	5	PowerFLEX™ (KTE)	Reel of 2000	µA7805CKTER	µA7805C
		TO-220 (KC)	Tube of 50	µA7805CKC	µA7805C
		TO-220, short shoulder (KCS)	Tube of 20	µA7805CKCS	
	8	PowerFLEX (KTE)	Reel of 2000	µA7808CKTER	µA7808C
		TO-220 (KC)	Tube of 50	µA7808CKC	µA7808C
		TO-220, short shoulder (KCS)	Tube of 20	µA7808CKCS	
	10	PowerFLEX (KTE)	Reel of 2000	µA7810CKTER	µA7810C
		TO-220 (KC)	Tube of 50	µA7810CKC	µA7810C
	12	PowerFLEX (KTE)	Reel of 2000	µA7812CKTER	µA7812C
		TO-220 (KC)	Tube of 50	µA7812CKC	µA7812C
		TO-220, short shoulder (KCS)	Tube of 20	µA7812CKCS	
	15	PowerFLEX (KTE)	Reel of 2000	µA7815CKTER	µA7815C
		TO-220 (KC)	Tube of 50	µA7815CKC	µA7815C
		TO-220, short shoulder (KCS)	Tube of 20	µA7815CKCS	
	24	PowerFLEX (KTE)	Reel of 2000	µA7824CKTER	µA7824C
		TO-220 (KC)	Tube of 50	µA7824CKC	µA7824C

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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TEXAS INSTRUMENTS

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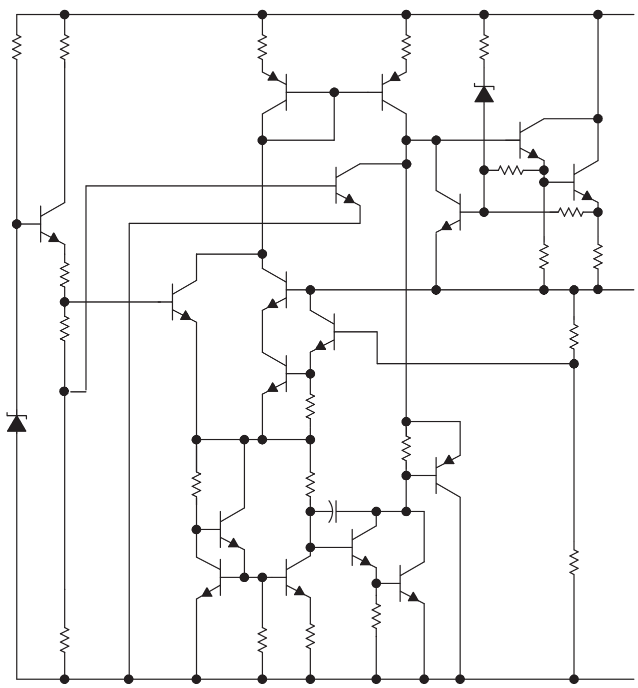
schematic



absolute maximum ratings over virtual junction temperature range (unless otherwise noted)†

Input voltage, V_I: μA7824C . . . 40 V
All others . . . 35 V
Operating virtual junction temperature, T_J . . . 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . 260°C
Storage temperature range, T_{stg} . . . −65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

package thermal data (see Note 1)

PACKAGE	BOARD	θ_{JC}	θ_{JA}	θ_{JP}‡
PowerFLEX (KTE)	High K, JESD 51-5	3°C/W	23°C/W	
TO-220 (KC/KCS)	High K, JESD 51-5	17°C/W	19°C/W	3°C/W

NOTE 1: Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

‡ For packages with exposed thermal pads, such as QFN, PowerPAD, or PowerFLEX, θ_{JP} is defined as the thermal resistance between the die junction and the bottom of the exposed pad.

recommended operating conditions

			MIN	MAX	UNIT
V_I	Input voltage	µA7805C	7	25	V
		µA7808C	10.5	25	
		µA7810C	12.5	28	
		µA7812C	14.5	30	
		µA7815C	17.5	30	
		µA7824C	27	38	
I_O	Output current			1.5	A
T_J	Operating virtual junction temperature	µA7800C series	0	125	°C

electrical characteristics at specified virtual junction temperature, V_I = 10 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_J†	µA7805C			UNIT
			MIN	TYP	MAX	
Output voltage	I_O = 5 mA to 1 A, V_I = 7 V to 20 V, $P_D \leq$ 15 W	25°C	4.8	5	5.2	V
		0°C to 125°C	4.75		5.25	
Input voltage regulation	V_I = 7 V to 25 V	25°C		3	100	mV
	V_I = 8 V to 12 V			1	50	
Ripple rejection	V_I = 8 V to 18 V, f = 120 Hz	0°C to 125°C	62	78		dB
Output voltage regulation	I_O = 5 mA to 1.5 A	25°C		15	100	mV
	I_O = 250 mA to 750 mA			5	50	
Output resistance	f = 1 kHz	0°C to 125°C		0.017		Ω
Temperature coefficient of output voltage	I_O = 5 mA	0°C to 125°C		−1.1		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		40		µV
Dropout voltage	I_O = 1 A	25°C		2		V
Bias current		25°C		4.2	8	mA
Bias current change	V_I = 7 V to 25 V	0°C to 125°C			1.3	mA
	I_O = 5 mA to 1 A				0.5	
Short-circuit output current		25°C		750		mA
Peak output current		25°C		2.2		A

† Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-µF capacitor across the input and a 0.1-µF capacitor across the output.

electrical characteristics at specified virtual junction temperature, V_I = 14 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_J†	μA7808C			UNIT
			MIN	TYP	MAX	
Output voltage	I_O = 5 mA to 1 A, V_I = 10.5 V to 23 V, P_D ≤ 15 W	25°C	7.7	8	8.3	V
		0°C to 125°C	7.6		8.4	
Input voltage regulation	V_I = 10.5 V to 25 V	25°C		6	160	mV
	V_I = 11 V to 17 V			2	80	
Ripple rejection	V_I = 11.5 V to 21.5 V, f = 120 Hz	0°C to 125°C	55	72		dB
Output voltage regulation	I_O = 5 mA to 1.5 A	25°C		12	160	mV
	I_O = 250 mA to 750 mA			4	80	
Output resistance	f = 1 kHz	0°C to 125°C		0.016		Ω
Temperature coefficient of output voltage	I_O = 5 mA	0°C to 125°C		−0.8		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		52		μV
Dropout voltage	I_O = 1 A	25°C		2		V
Bias current		25°C		4.3	8	mA
Bias current change	V_I = 10.5 V to 25 V	0°C to 125°C			1	mA
	I_O = 5 mA to 1 A				0.5	
Short-circuit output current		25°C		450		mA
Peak output current		25°C		2.2		A

† Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output.

electrical characteristics at specified virtual junction temperature, V_I = 17 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_J†	μA7810C			UNIT
			MIN	TYP	MAX	
Output voltage	I_O = 5 mA to 1 A, V_I = 12.5 V to 25 V, P_D ≤ 15 W	25°C	9.6	10	10.4	V
		0°C to 125°C	9.5	10	10.5	
Input voltage regulation	V_I = 12.5 V to 28 V	25°C		7	200	mV
	V_I = 14 V to 20 V			2	100	
Ripple rejection	V_I = 13 V to 23 V, f = 120 Hz	0°C to 125°C	55	71		dB
Output voltage regulation	I_O = 5 mA to 1.5 A	25°C		12	200	mV
	I_O = 250 mA to 750 mA			4	100	
Output resistance	f = 1 kHz	0°C to 125°C		0.018		Ω
Temperature coefficient of output voltage	I_O = 5 mA	0°C to 125°C		−1		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		70		μV
Dropout voltage	I_O = 1 A	25°C		2		V
Bias current		25°C		4.3	8	mA
Bias current change	V_I = 12.5 V to 28 V	0°C to 125°C			1	mA
	I_O = 5 mA to 1 A				0.5	
Short-circuit output current		25°C		400		mA
Peak output current		25°C		2.2		A

† Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output.

electrical characteristics at specified virtual junction temperature, V_I = 19 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_J†	μA7812C MIN	μA7812C TYP	μA7812C MAX	UNIT
Output voltage	I_O = 5 mA to 1 A, V_I = 14.5 V to 27 V, P_D ≤ 15 W	25°C	11.5	12	12.5	V
		0°C to 125°C	11.4		12.6	
Input voltage regulation	V_I = 14.5 V to 30 V	25°C		10	240	mV
	V_I = 16 V to 22 V			3	120	
Ripple rejection	V_I = 15 V to 25 V, f = 120 Hz	0°C to 125°C	55	71		dB
Output voltage regulation	I_O = 5 mA to 1.5 A	25°C		12	240	mV
	I_O = 250 mA to 750 mA			4	120	
Output resistance	f = 1 kHz	0°C to 125°C		0.018		Ω
Temperature coefficient of output voltage	I_O = 5 mA	0°C to 125°C		−1		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		75		μV
Dropout voltage	I_O = 1 A	25°C		2		V
Bias current		25°C		4.3	8	mA
Bias current change	V_I = 14.5 V to 30 V	0°C to 125°C			1	mA
	I_O = 5 mA to 1 A				0.5	
Short-circuit output current		25°C		350		mA
Peak output current		25°C		2.2		A

† Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output.

electrical characteristics at specified virtual junction temperature, V_I = 23 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_J†	μA7815C MIN	μA7815C TYP	μA7815C MAX	UNIT
Output voltage	I_O = 5 mA to 1 A, V_I = 17.5 V to 30 V, P_D ≤ 15 W	25°C	14.4	15	15.6	V
		0°C to 125°C	14.25		15.75	
Input voltage regulation	V_I = 17.5 V to 30 V	25°C		11	300	mV
	V_I = 20 V to 26 V			3	150	
Ripple rejection	V_I = 18.5 V to 28.5 V, f = 120 Hz	0°C to 125°C	54	70		dB
Output voltage regulation	I_O = 5 mA to 1.5 A	25°C		12	300	mV
	I_O = 250 mA to 750 mA			4	150	
Output resistance	f = 1 kHz	0°C to 125°C		0.019		Ω
Temperature coefficient of output voltage	I_O = 5 mA	0°C to 125°C		−1		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		90		μV
Dropout voltage	I_O = 1 A	25°C		2		V
Bias current		25°C		4.4	8	mA
Bias current change	V_I = 17.5 V to 30 V	0°C to 125°C			1	mA
	I_O = 5 mA to 1 A				0.5	
Short-circuit output current		25°C		230		mA
Peak output current		25°C		2.1		A

† Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output.

electrical characteristics at specified virtual junction temperature, V_I = 33 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_J†	μA7824C MIN	μA7824C TYP	μA7824C MAX	UNIT
Output voltage	I_O = 5 mA to 1 A, V_I = 27 V to 38 V, $P_D \le$ 15 W	25°C	23	24	25	V
		0°C to 125°C	22.8		25.2	
Input voltage regulation	V_I = 27 V to 38 V	25°C		18	480	mV
	V_I = 30 V to 36 V			6	240	
Ripple rejection	V_I = 28 V to 38 V, f = 120 Hz	0°C to 125°C	50	66		dB
Output voltage regulation	I_O = 5 mA to 1.5 A	25°C		12	480	mV
	I_O = 250 mA to 750 mA			4	240	
Output resistance	f = 1 kHz	0°C to 125°C		0.028		Ω
Temperature coefficient of output voltage	I_O = 5 mA	0°C to 125°C		−1.5		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		170		μV
Dropout voltage	I_O = 1 A	25°C		2		V
Bias current		25°C		4.6	8	mA
Bias current change	V_I = 27 V to 38 V	0°C to 125°C			1	mA
	I_O = 5 mA to 1 A				0.5	
Short-circuit output current		25°C		150		mA
Peak output current		25°C		2.1		A

† Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output.

APPLICATION INFORMATION

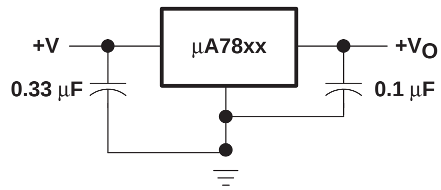


Figure 1. Fixed-Output Regulator

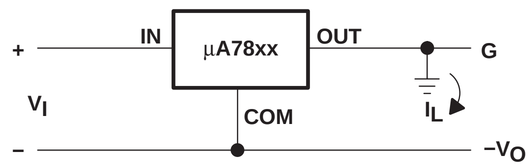
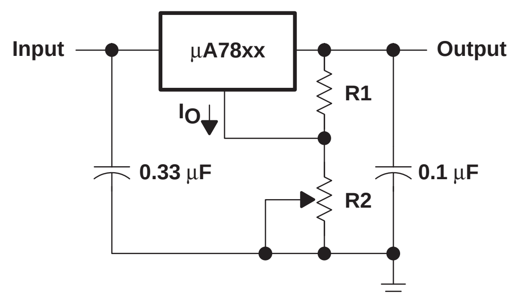


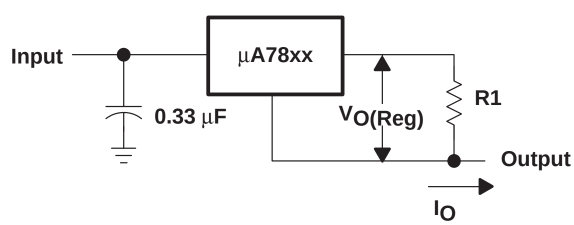
Figure 2. Positive Regulator in Negative Configuration (V_I Must Float)



NOTE A: The following formula is used when V_{xx} is the nominal output voltage (output to common) of the fixed regulator:

$$V_O = V_{xx} + \left(\frac{V_{xx}}{R1} + I_Q\right)R2$$

Figure 3. Adjustable-Output Regulator



$I_O = (V_O/R1) + I_O$ Bias Current

Figure 4. Current Regulator

APPLICATION INFORMATION

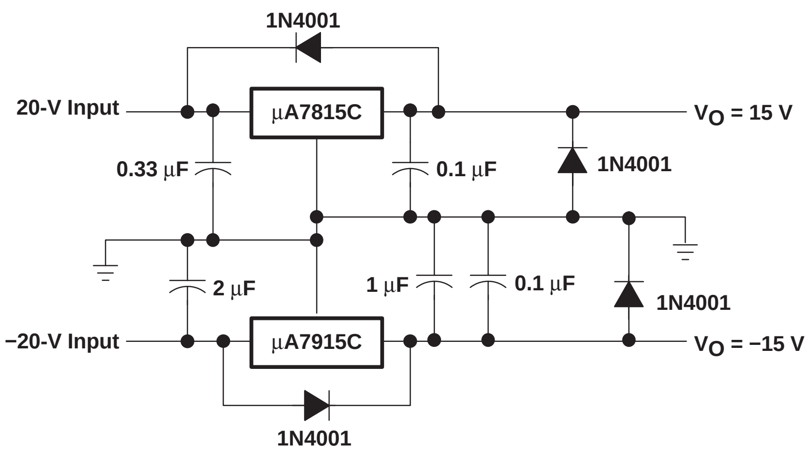


Figure 5. Regulated Dual Supply

operation with a load common to a voltage of opposite polarity

In many cases, a regulator powers a load that is not connected to ground but, instead, is connected to a voltage source of opposite polarity (e.g., operational amplifiers, level-shifting circuits, etc.). In these cases, a clamp diode should be connected to the regulator output as shown in Figure 6. This protects the regulator from output polarity reversals during startup and short-circuit operation.

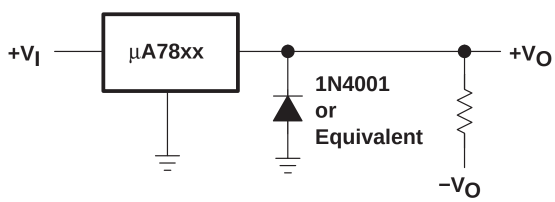


Figure 6. Output Polarity-Reversal-Protection Circuit

reverse-bias protection

Occasionally, the input voltage to the regulator can collapse faster than the output voltage. This can occur, for example, when the input supply is crowbarred during an output overvoltage condition. If the output voltage is greater than approximately 7 V, the emitter-base junction of the series-pass element (internal or external) could break down and be damaged. To prevent this, a diode shunt can be used as shown in Figure 7.

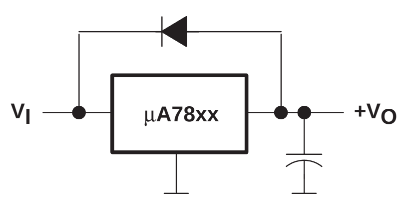


Figure 7. Reverse-Bias-Protection Circuit

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
UA7805CKC	NRND	TO-220	KC	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7805CKCE3	ACTIVE	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA7805CKCS	ACTIVE	TO-220	KCS	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7805CKTER	NRND	PFM	KTE	3	2000	TBD	CU SNPB	Level-1-220C-UNLIM
UA7805QKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA7805QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7806CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA7806CKTER	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7806QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7806QKTER	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7808CKC	NRND	TO-220	KC	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7808CKCE3	ACTIVE	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA7808CKCS	ACTIVE	TO-220	KCS	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7808CKTER	NRND	PFM	KTE	3	2000	TBD	CU SNPB	Level-1-220C-UNLIM
UA7808QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7810CKC	NRND	TO-220	KC	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7810CKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA7810CKCS	ACTIVE	TO-220	KCS	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7810CKTER	NRND	PFM	KTE	3	2000	TBD	CU SNPB	Level-1-220C-UNLIM
UA7810QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7812CKC	NRND	TO-220	KC	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7812CKCS	ACTIVE	TO-220	KCS	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7812CKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA7812CKTER	NRND	PFM	KTE	3	2000	TBD	CU SNPB	Level-1-220C-UNLIM
UA7812QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7815CKC	NRND	TO-220	KC	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7815CKCS	ACTIVE	TO-220	KCS	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7815CKTER	NRND	PFM	KTE	3	2000	TBD	CU SNPB	Level-1-220C-UNLIM
UA7815QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7818CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA7818CKTER	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7824CKC	NRND	TO-220	KC	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7824CKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA7824CKCS	ACTIVE	TO-220	KCS	3	50	TBD	CU SNPB	N / A for Pkg Type
UA7824CKTER	NRND	PFM	KTE	3	2000	TBD	CU SNPB	Level-1-220C-UNLIM
UA7885CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA7885CKTER	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI
UA7885QKTE	OBSOLETE	PFM	KTE	3		TBD	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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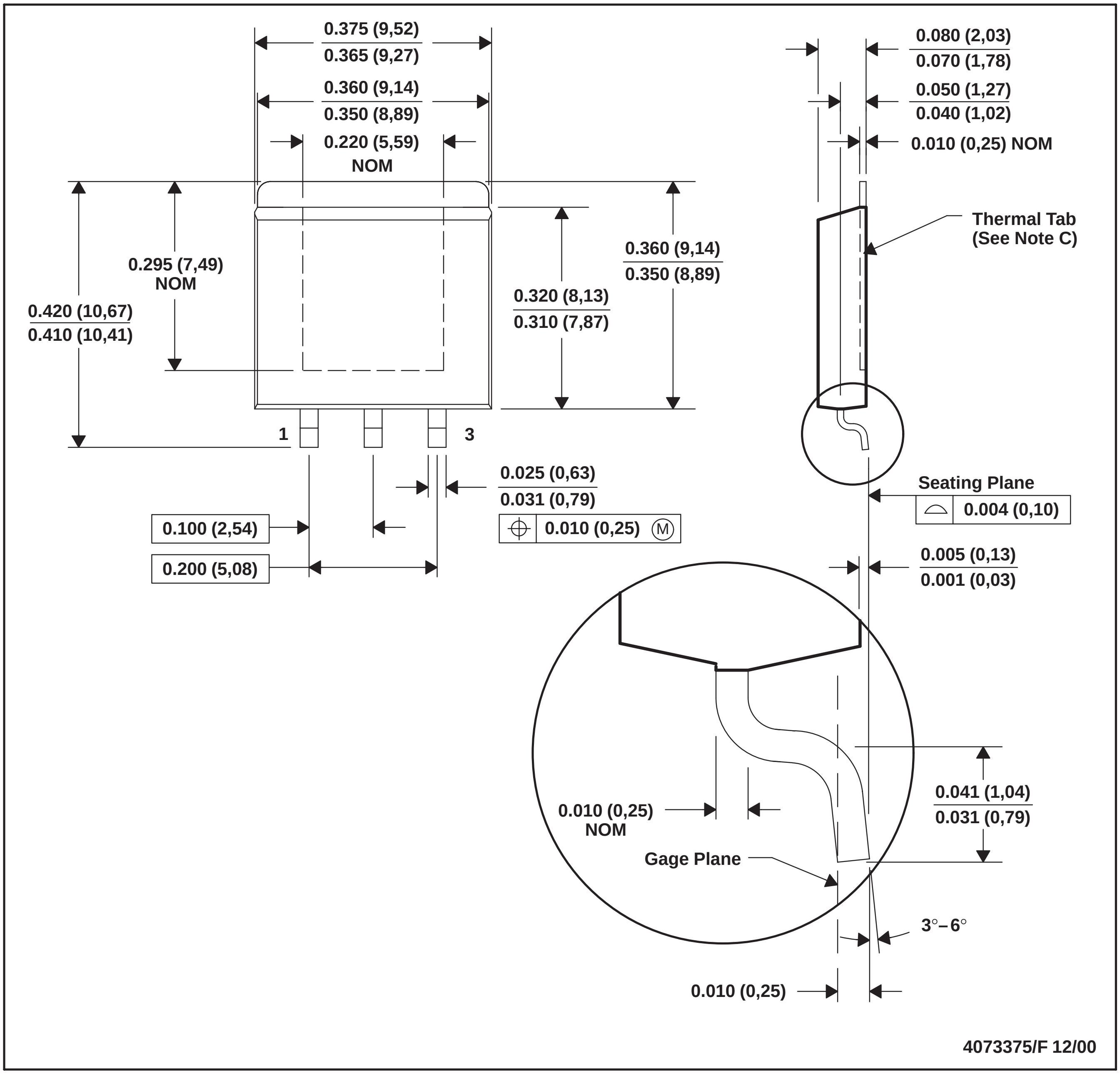
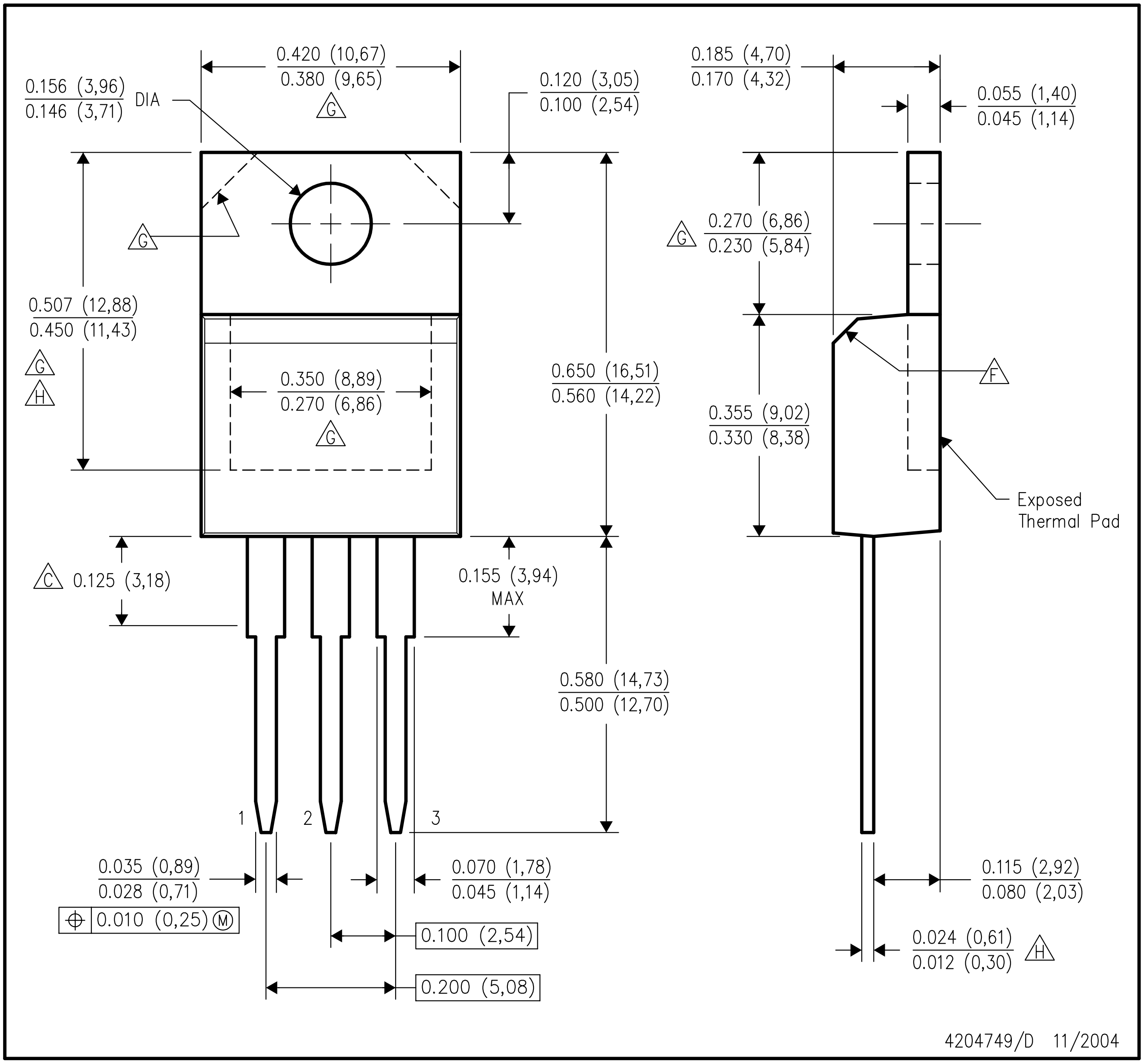
KTE (R-PSFM-G3) **PowerFLEX™ PLASTIC FLANGE-MOUNT**



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. The center lead is in electrical contact with the thermal tab.
D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
E. Falls within JEDEC MO-169

PowerFLEX is a trademark of Texas Instruments.

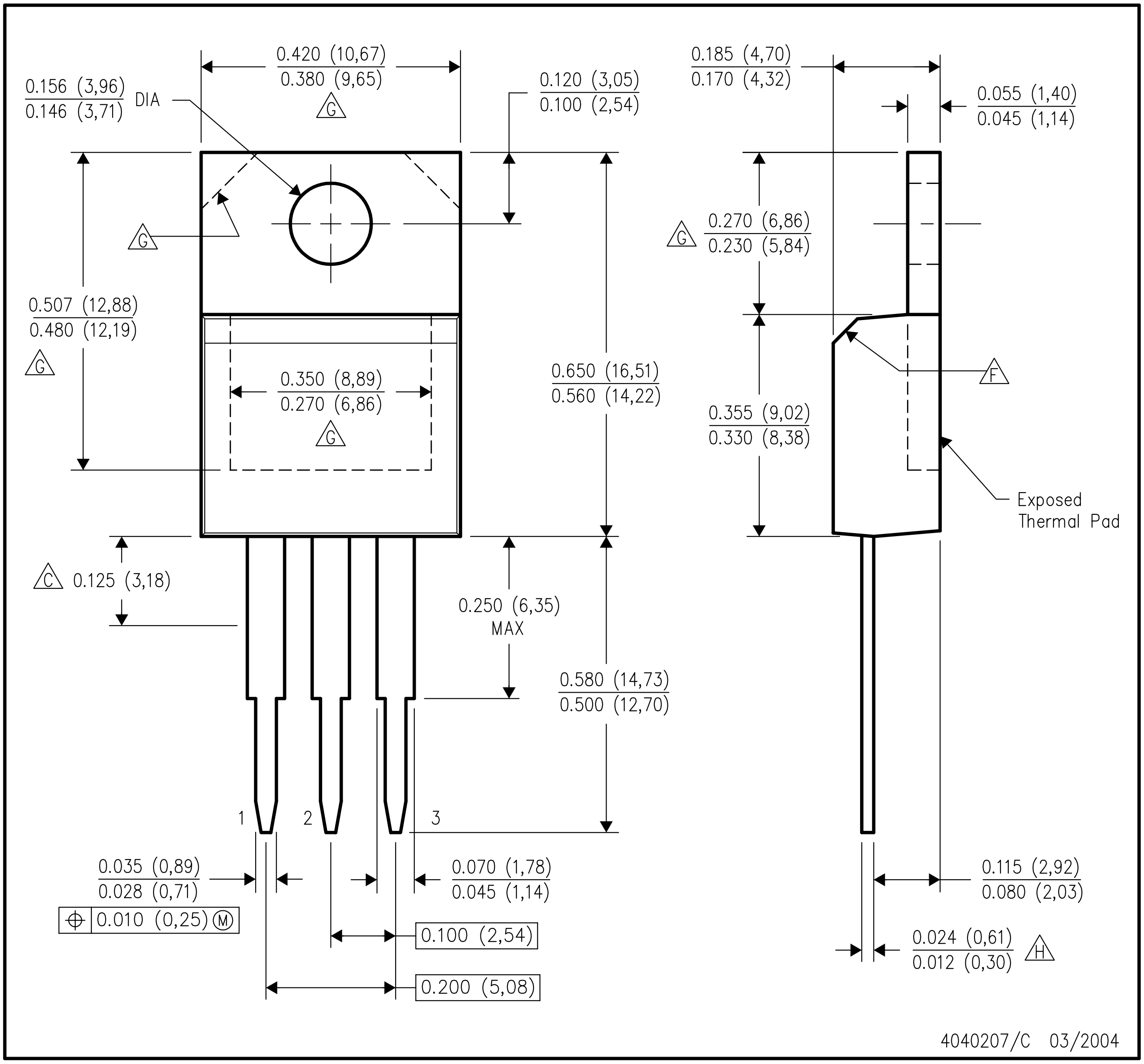
KCS (R–PSFM–T3) PLASTIC FLANGE–MOUNT PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- F. The chamfer is optional.
- G. Thermal pad contour optional within these dimensions.
- H. Falls within JEDEC TO–220 variation AB, except minimum lead thickness and minimum exposed pad length.

KC (R–PSFM–T3) PLASTIC FLANGE–MOUNT PACKAGE



NOTES:
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- F. The chamfer is optional.
- G. Thermal pad contour optional within these dimensions.
- H. Falls within JEDEC TO–220 variation AB, except minimum lead thickness.

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